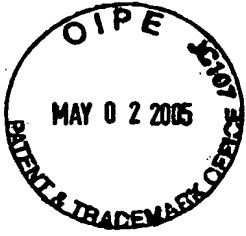


5-4-05

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: B. GHYSELEN et al

Confirmation No. 9199

Application No: 10/764,289

Group Art Unit: 2812

Filing Date: January 23, 2004

Examiner: D.A. Le

For: RECYCLING OF A WAFER COMPRISING  
A BUFFER LAYER, AFTER HAVING  
SEPARATED A THIN LAYER  
THEREFROM

Atty. Docket No.: 4717-8500

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

In response to the Office action dated April 22, 2005, applicants submit here with the following response and remarks for entry into the file of this application.

**AMENDMENTS TO THE CLAIMS** appear herein starting on page 2.

**REMARKS** appear herein starting on page 8.

Two sheets of substitute drawings are submitted herewith

A Terminal Disclaimer, with fee authorization, is submitted herewith.

No other fees are believed to be due for this submission. Should any further fees be required, however, please charge such fees to Winston & Strawn LLP Deposit Account No. 50-1814.